## G3VM-21GR1

**MOS FET Relays** 

# MOS FET Relays with Low Output Capacitance and ON Resistance ( $C \times R = 5pF \cdot \Omega$ ) in a 20-V Load Voltage Model.



- ullet ON resistance of 1  $\Omega$  (typical) suppresses output signal attenuation.
- Leakage current of 1.0 nA max. when output relay is open.

**RoHS** compliant

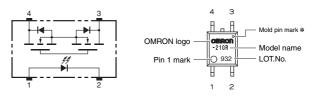


Note: The actual product is marked differently from the image shown here.

#### ■ Application Examples

- Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Data loggers

## ■ Terminal Arrangement/Internal Connections



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\* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

#### **■ List of Models**

Package type	Contact form	Terminals	Load voltage	Model	Minimum package quantity	
			(peak value) *	woder	Number per tube	Number per tape and reel
SOP4	1a (SPST-NO)	Surface-mounting Terminals	20 V	G3VM-21GR1	100	-
				G3VM-21GR1 (TR)	-	2,500

<sup>\*</sup> The AC peak and DC value are given for the load voltage.

#### ■ Absolute Maximum Ratings (Ta = 25°C)

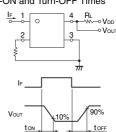
Item		Symbol	Rating	Unit	Measurement conditions		
	LED forward current	lF	50	mA			
Ħ	LED forward current reduction rate	∆lf/°C	-0.5	mA/°C	Ta ≥ 25°C		
lnp	LED reverse voltage	VR	5	٧			
	Connection temperature	TJ	125	°C			
	Load voltage (AC peak/DC)	Voff	20	٧			
Output	Continuous load current (AC peak/DC)	lo	300	mA			
Ĕ	ON current reduction rate	∆lo/°C	-3.0	mA/°C	Ta ≥ 25°C		
	Connection temperature	TJ	125	°C			
	lectric strength between (See note 1.)	V <sub>I</sub> -O	1500	Vrms	AC for 1 min		
Ambient operating temperature		Ta	-20 to +85	°C	With no icing or condensation		
Ambient storage temperature		Tstg	-55 to +125	°C	With no icing or condensation		
Soldering temperature			260	°	10 s		

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

#### **■ Electrical Characteristics** (Ta = 25°C)

	Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
	LED forward voltage	VF	1.0	1.15	1.3	٧	IF = 10 mA
Input	Reverse current	lr	-	-	10	μА	VR = 5 V
n H	Capacity between terminals	Ст	-	15	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	-	4	mΑ	lo = 100 mA
Ħ	Maximum resistance with output ON	Ron	-	1	1.5	Ω	$I_F = 5 \text{ mA}, I_O = 300 \text{ mA}, t < 1 \text{ s}$
Output	Current leakage when the relay is open	ILEAK	-	-	1.0	nΑ	Voff = 20 V, Ta = 50 °C
	Capacity between terminals	Coff	-	5	12	pF	V = 0, $f = 100 MHz$ , $t < 1 s$
Capacity between I/O terminals		C <sub>I</sub> -O	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		Rı-o	1000	-	-	МΩ	V <sub>I</sub> -o = 500 VDC, RoH ≤ 60 %
Turn-ON time		ton	-	-	0.5	ms	IF = 10 mA, RL = 200 $\Omega$ ,
Turn-OFF time		toff	-	-	0.5	ms	V <sub>DD</sub> = 20 V (See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



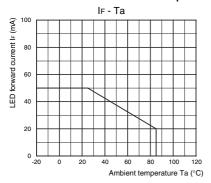
#### **■** Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

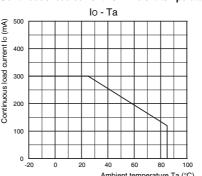
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V <sub>DD</sub>	-	-	20	V
Operating LED forward current	lF	7	-	30	mA
Continuous load current (AC peak/DC)	lo	-	-	300	mA
Ambient operating temperature	Ta	25	-	60	°C

#### **■** Engineering Data

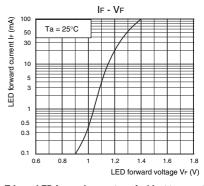
#### LED forward current vs. Ambient temperature



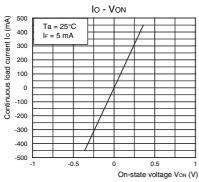
Continuous load current vs. Ambient temperature



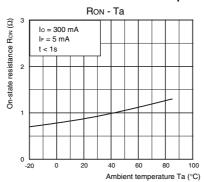
LED forward current vs. LED forward voltage



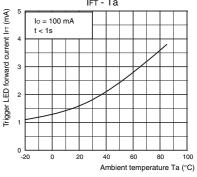
Continuous load current vs. On-state voltage



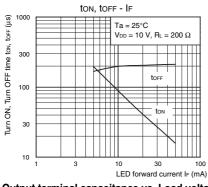
On-state resistance vs. Ambient temperature

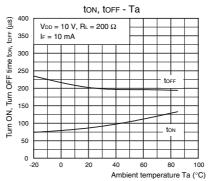


Trigger LED forward current vs. Ambient temperature

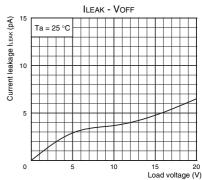


Turn ON, Turn OFF time vs. LED forward current Turn ON, Turn OFF time vs. Ambient temperature

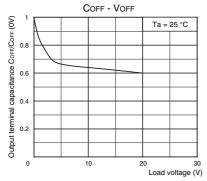




Current leakage vs. Load voltage



Output terminal capacitance vs. Load voltage



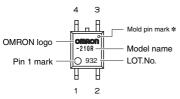
#### **■** Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

#### **■** Appearance

#### SOP (Small Outline Package)

SOP4



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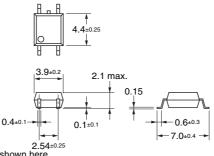
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#### ■ Dimensions (Unit: mm)



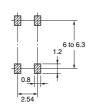
#### Surface-mounting Terminals

Weight: 0.1 g



### **Actual Mounting Pad Dimensions**

(Recommended Value, TOP VIEW)



Note: The actual product is marked differently from the image shown here.

Note: Do not use this document to operate the Unit.

Contact: www.omron.com/ecb

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.

<sup>•</sup> Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.